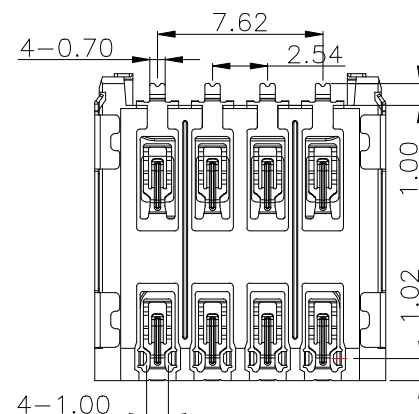
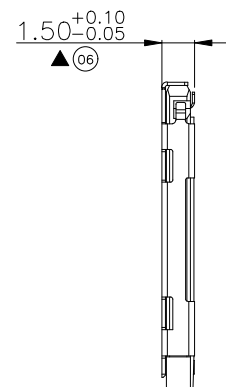
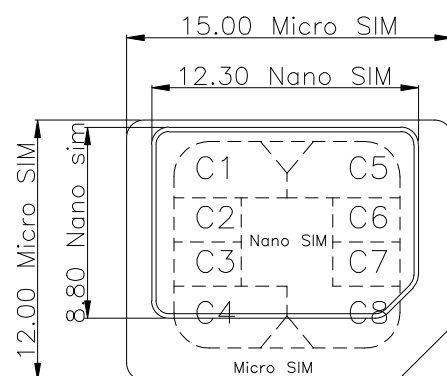
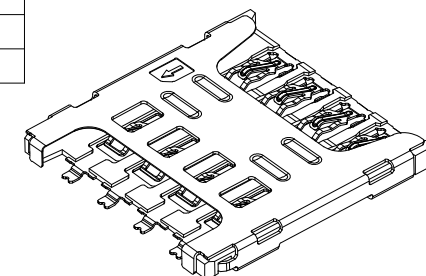
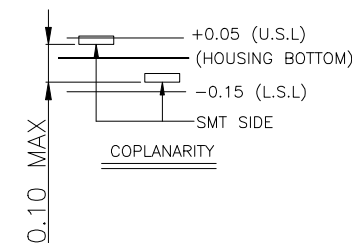
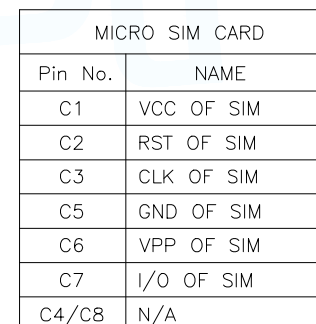
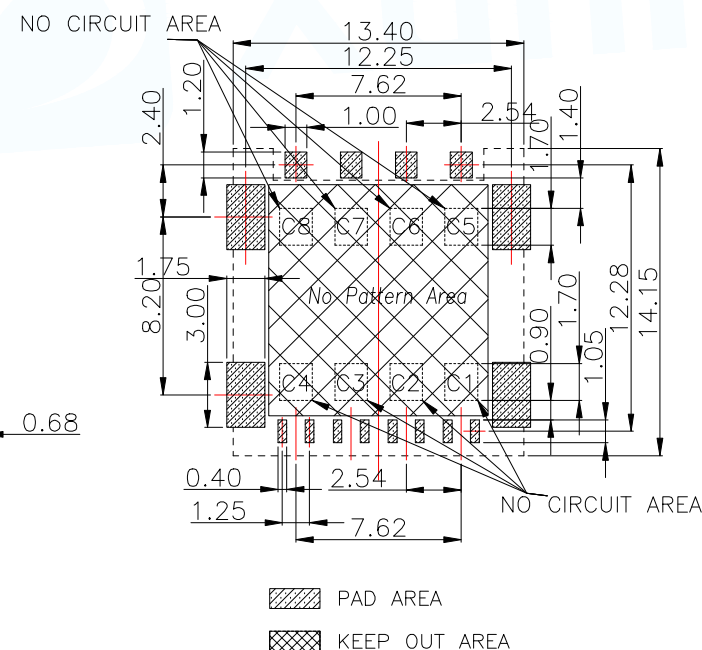
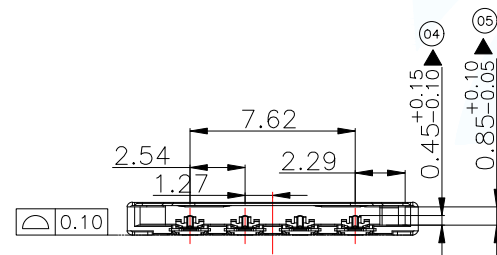




1. ELECTRICAL CHARACTERISTICS
 - 1-1. CONTACT RESISTANCE: 100 MILLIOHMS MAX
 - 1-2. INSULATION RESISTANCE: 1,000 MEGOHMS MIN.
 - 1-3. VOLTAGE RATING: 50V.
 - 1-4. CURRENT RATING: 1.0A.
2. MECHANICAL CHARACTERISTICS
 - 2-1. OPERATION TEMPERATURE RANGE: $-40^{\circ}\text{C}\sim+85^{\circ}\text{C}$
 - 2-2. DURABILITY: 5000 CYCLES
3. MATERIAL:
 - 3-1. HOUSING: THERMOPLASTIC,UL 94-V0
 - 3-2. CONTACT: COPPER ALLOY,T=0.10
 - 3-3. SHELL: STAINLESS STEEL,T=0.15
4. FINISHED:
 - 4-1. CONTACT: NI PLATED UNDER,AU PLATED ON
CONTACT AREA,G/F PLATED ON SOLDER TAIL
 - 4-2. SHELL: NI PLATED UNDER,G/F PLATED ON
SOLDER TAIL



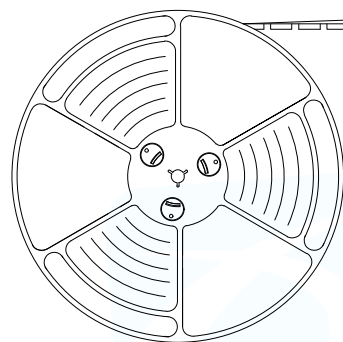
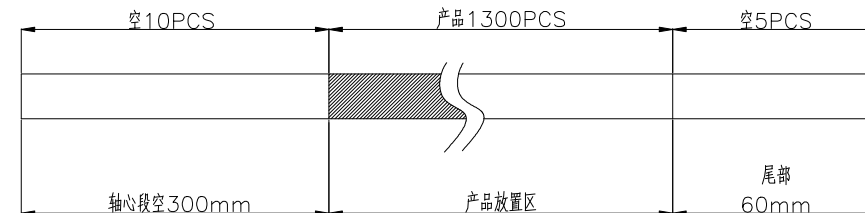
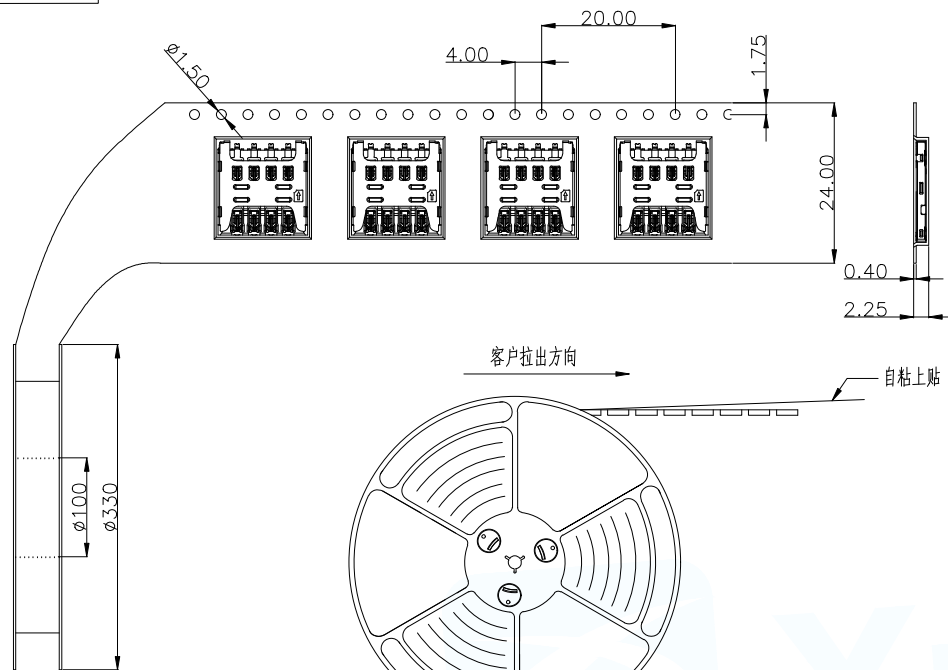
RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ± 0.05

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:MICRO SIM CARD PUSH PULL 8PIN H1.5	
			PAR	SMC-218-ARP8
DECIMALS:	ANGLES:		DWN	
X.:±0.50	X*.:±2°		CHKD	
X.X:±0.30	X.X*.:±1°		APVD	
X.XX:±0.20		CUSTOMER COPY	SCALE1:1	UNIT:MM
			SIZE:A4	SHEET:1F1
				REV:A

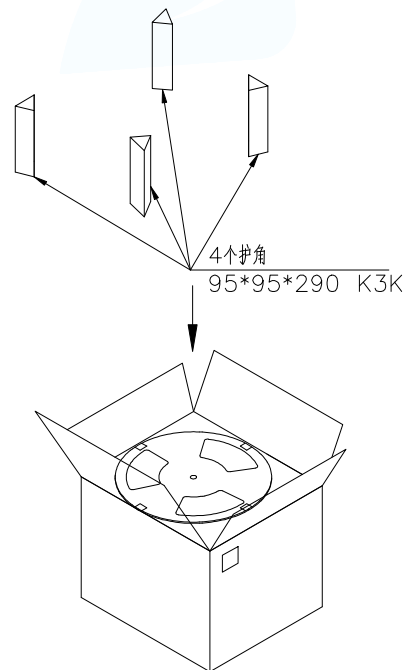
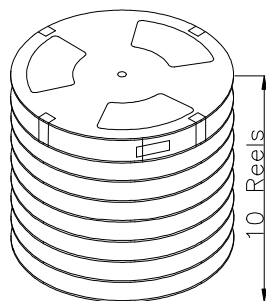
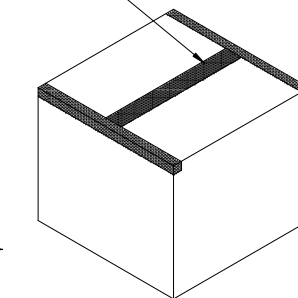
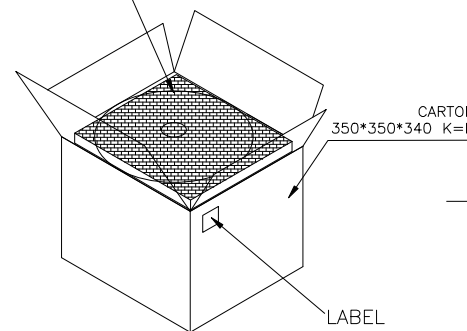
ROHS Compliant

MAPX	MODIFICATION	DATE	DRAW	APPROVE



上下各1PCS珍珠棉

胶纸工字型封箱



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MICRO SIM CARD PUSH PULL 8PIN H1.5 包装图
DECIMALS:	ANGLES:		PAR SMC-218-ARP8
X.: ±0.50	X'': ±2°		DWN
X.X: ±0.30	X.X': ±1°		CHKD
X.XX: ±0.20			APVD
CUSTOMER COPY		SCALE 1:1	UNIT: MM
		SIZE: A4	UNIT: MM
		SHEET: 1F1	REV: A